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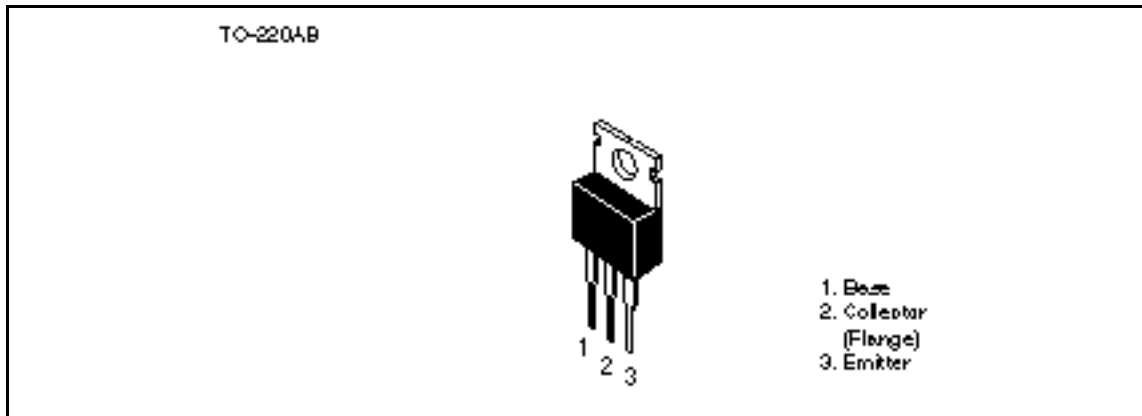
Silicon NPN Triple Diffused

HITACHI

Application

High voltage, high speed and high power switching

Outline



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	500	V
Collector to emitter voltage	V_{CEO}	400	V
Emitter to base voltage	V_{EBO}	7	V
Collector current	I_C	5	A
Collector peak current	$I_{C(peak)}$	10	A
Base current	I_B	2.5	A
Collector power dissipation	P_C^{*1}	40	W
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

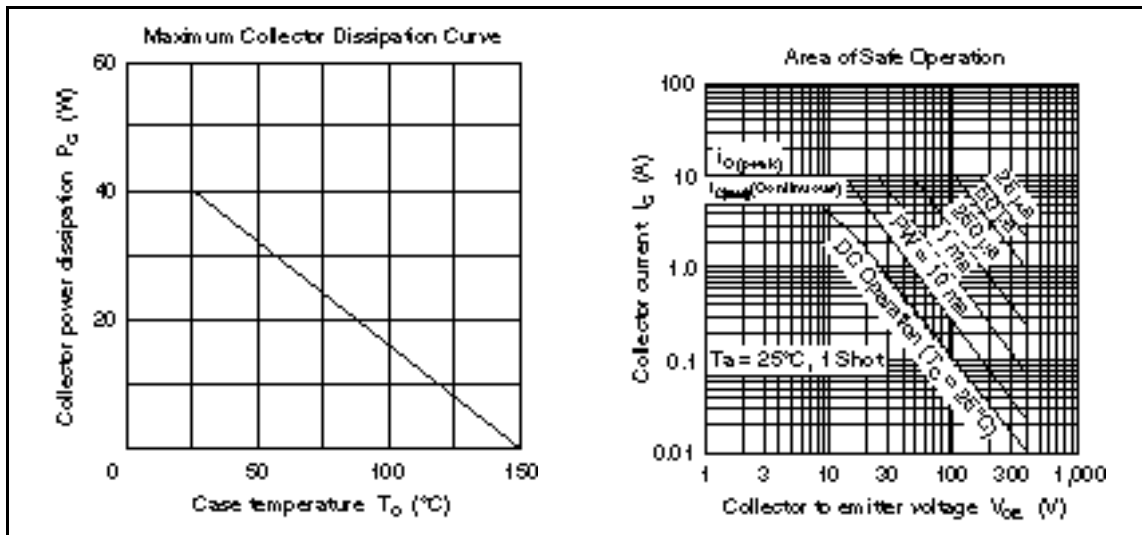
Note: 1. Value at $T_C = 25^\circ\text{C}$.

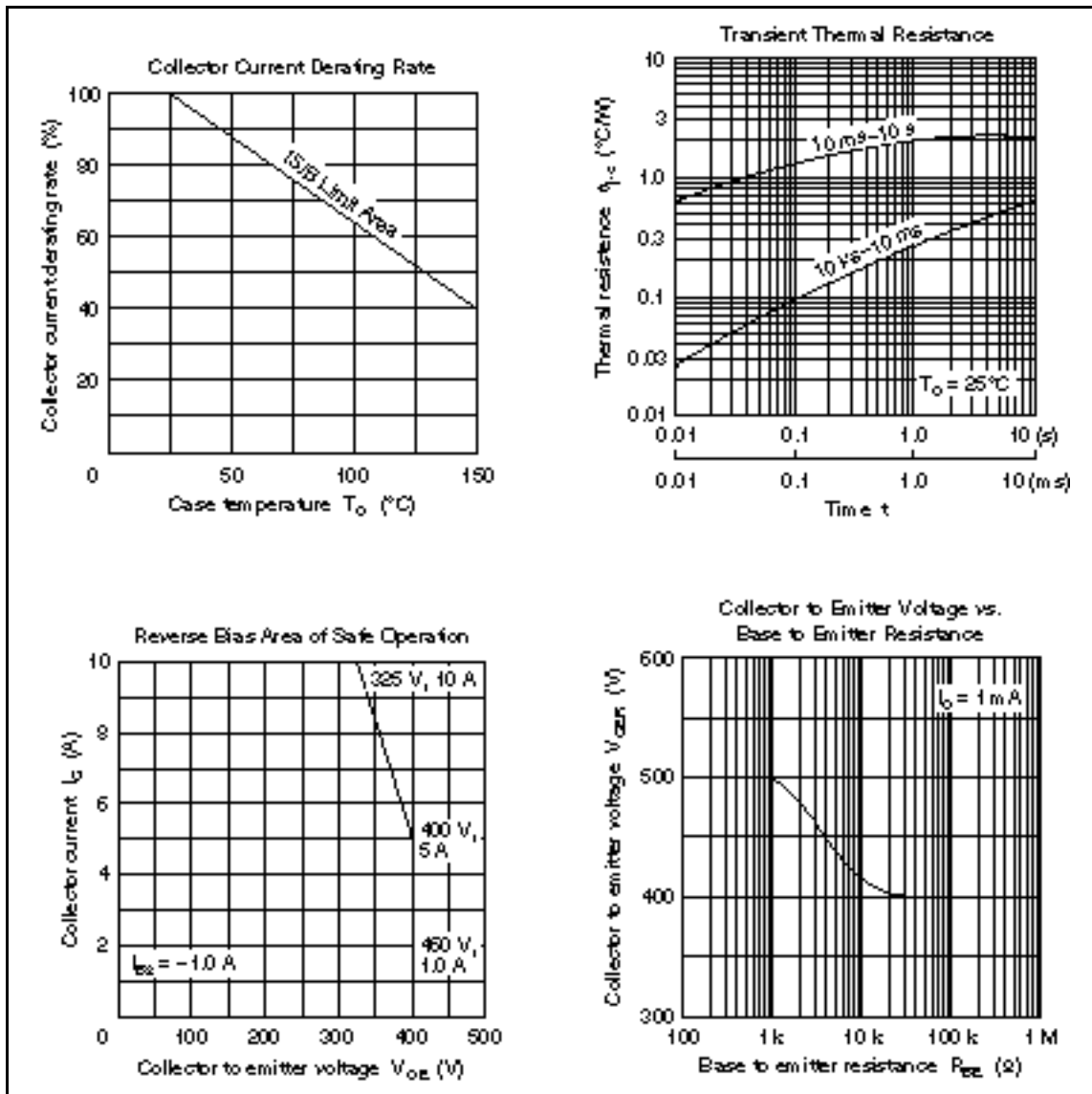
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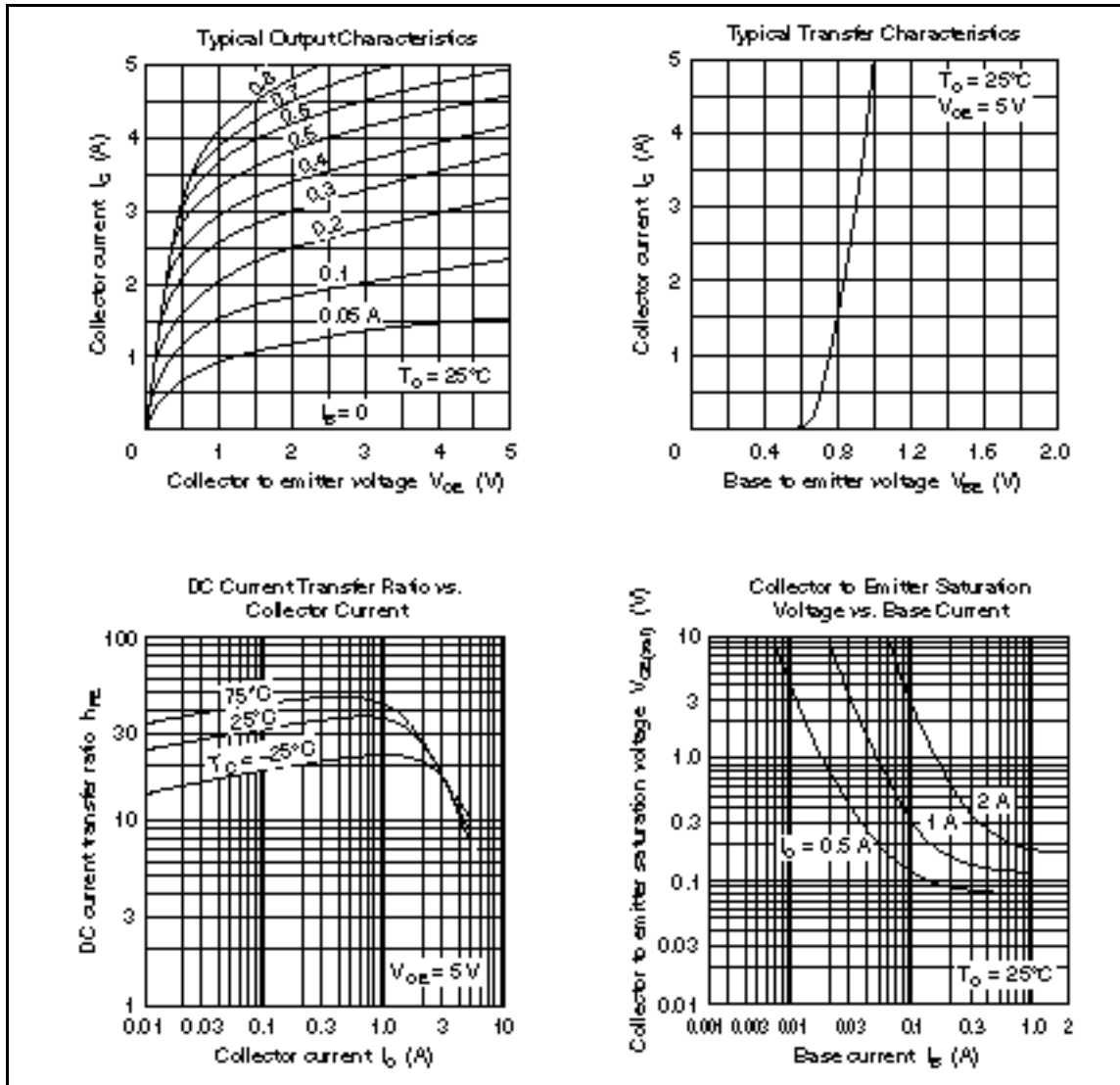
Electrical Characteristics (Ta = 25°C)

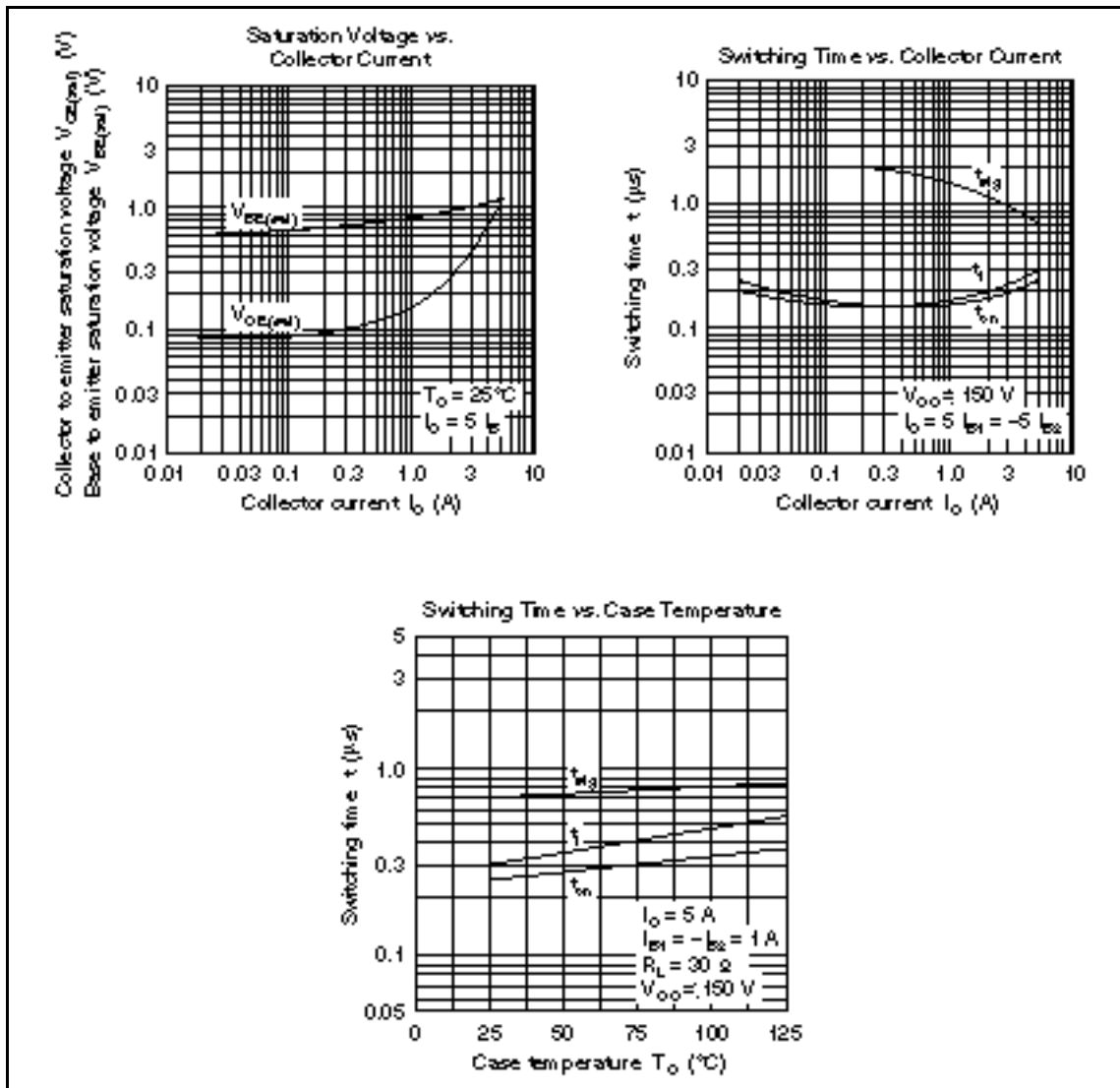
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to emitter sustain voltage	$V_{CEO(sus)}$	400	—	—	V	$I_C = 0.2$ A, $R_{BE} =$, $L = 100$ mH
	$V_{CEX(sus)}$	400	—	—	V	$I_C = 5$ A, $I_{B1} = -I_{B2} = 1.0$ A $V_{BE} = -5.0$ V, $L = 180$ μ H, Clamped
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7	—	—	V	$I_E = 10$ mA, $I_C = 0$
Collector cutoff current	I_{CBO}	—	—	50	μ A	$V_{CB} = 400$ V, $I_E = 0$
	I_{CEO}	—	—	50	μ A	$V_{CE} = 350$ V, $R_{BE} =$
DC current transfer ratio	h_{FE1}	15	—	—		$V_{CE} = 5.0$ V, $I_C = 2.5$ A* ¹
	h_{FE2}	7	—	—		$V_{CE} = 5.0$ V, $I_C = 5$ A* ¹
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	1.0	V	$I_C = 2.5$ A, $I_B = 0.5$ A* ¹
Base to emitter saturation voltage	$V_{BE(sat)}$	—	—	1.5	V	$I_C = 2.5$ A, $I_B = 0.5$ A* ¹
Turn on time	t_{on}	—	—	0.5	μ s	$I_C = 5$ A, $I_{B1} = -I_{B2} = 1.0$ A,
Storage time	t_{stg}	—	—	1.5	μ s	$V_{CC} = 150$ V
Fall time	t_f	—	0.3	0.5	μ s	

Note: 1. Pulse test.









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